# Low Voltage Dual SPDT Analog Switch Dual 2:1 Multiplexer

The NLAS3158 is an advanced CMOS analog switch fabricated with silicon gate CMOS technology. It achieves very low propagation delay and RDS $_{ON}$  resistances while maintaining CMOS low power dissipation. Analog and digital voltages that may vary across the full power–supply range (from  $V_{CC}$  to GND). This device is a drop in replacement for the PI5A3158.

The select pin has overvoltage protection that allows voltages above  $V_{CC}$ , up to 7.0 V to be present on the pin without damage or disruption of operation of the part, regardless of the operating voltage.

#### **Features**

- High Speed:  $t_{PD} = 1.0 \text{ ns (Typ)}$  at  $V_{CC} = 5.0 \text{ V}$
- Low Power Dissipation:  $I_{CC} = 1.0 \mu A$  (Max) at  $T_A = 25^{\circ}C$
- Standard CMOS Logic Levels
- High Bandwidth, Improved Linearity
- Low RDS<sub>ON</sub>: 8 Ω Max at 3 V
- Break Before Make Circuitry, Prevents Inadvertent Shorts
- This is a Pb-Free Device

#### **Typical Applications**

- Switches Standard NTSC/PAL Video, Audio, SPDIF and HDTV
- May be used for Clock Switching, Data MUX'ing, etc.
- Can Switch Balanced Signal Pairs, e.g. LVDS > 200 Mb/s

#### **Important Information**

- Latchup Performance Exceeds 300 mA
- Pin for Pin Drop in for PI5A3158
- WDFN Package, 3x1 mm
- ESD Performance: Human Body Model; > 2000 V; Machine Model; > 200 V
- Extended Automotive Temperature Range -55°C to +125°C (See Appendix A)



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WDFN12 MN SUFFIX CASE 485AG

#### **MARKING DIAGRAM**

ASM

o ■

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AS = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

#### **FUNCTION TABLE**

nnected to A

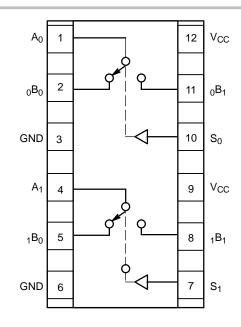


Figure 1. Pinout (Top View)

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 11 of this data sheet.

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Supply Voltage	V <sub>CC</sub>	-0.5 to +7.0	V
DC Switch Input Voltage (Note 1)	V <sub>IS</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC Input Voltage (Note 1)	V <sub>IN</sub>	-0.5 to + 7.0	V
DC Input Diode Current @ V <sub>IN</sub> < 0 V	I <sub>IK</sub>	-50	mA
DC Output Current	lout	128	mA
DC V <sub>CC</sub> or Ground Current	I <sub>CC</sub> /I <sub>GND</sub>	+100	mA
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Junction Temperature Under Bias	TJ	150	°C
Junction Lead Temperature (Soldering, 10 Seconds)	TL	260	°C
Power Dissipation @ +85°C	P <sub>D</sub>	180	mW

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

# **RECOMMENDED OPERATING CONDITIONS** (Note 2)

Characteristic	Symbol	Min	Max	Unit
Supply Voltage Operating	V <sub>CC</sub>	1.65	5.5	V
Select Input Voltage	V <sub>IN</sub>	0	V <sub>CC</sub>	V
Switch Input Voltage	V <sub>IS</sub>	0	V <sub>CC</sub>	V
Output Voltage	V <sub>OUT</sub>	0	V <sub>CC</sub>	V
Operating Temperature	T <sub>A</sub>	-55	+125	°C
Input Rise and Fall Time Control Input $V_{CC}$ = 2.3 V-3.6 V Control Input $V_{CC}$ = 4.5 V-5.5 V	t <sub>r</sub> , t <sub>f</sub>	0	10 5.0	ns/V
Thermal Resistance	$\theta_{\sf JA}$	-	350	°C/W

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

<sup>2.</sup> Select input must be held HIGH or LOW, it must not float.

# **DC ELECTRICAL CHARACTERISTICS** ( $T_A = -40^{\circ}C$ to $+85^{\circ}C$ )

			V <sub>CC</sub>	Т	A = +25°	С	T <sub>A</sub> = -40°	C to +85°C	
Symbol	Parameter	Test Conditions	(V)	Min	Тур	Max	Min	Max	Unit
V <sub>IH</sub>	HIGH Level Input Voltage		1.65–1.95 2.3–5.5				0.75 V <sub>CC</sub> 0.7 V <sub>CC</sub>		V
$V_{IL}$	LOW Level Input Voltage		1.65–1.95 2.3–5.5					0.25 V <sub>CC</sub> 0.3 V <sub>CC</sub>	V
I <sub>IN</sub>	Input Leakage Current	$0 \le V_{IN} \le 5.5 V$	0-5.5		±0.0 5	±0.1		±1	μΑ
I <sub>OFF</sub>	OFF State Leakage Current	0 ≤ A, B ≤ V <sub>CC</sub>	1.65–5.5		±0.0 5	±0.1		±1	μΑ
R <sub>ON</sub>	Switch On Resistance (Note 3)	$V_{IN} = 0 \text{ V, } I_O = 30 \text{ mA}$ $V_{IN} = 2.4 \text{ V, } I_O = -30 \text{ mA}$ $V_{IN} = 4.5 \text{ V, } I_O = -30 \text{ mA}$	4.5		3.0 5.0 7.0	6.0 8.0 13		6.0 8.0 13	Ω
		V <sub>IN</sub> = 0 V, I <sub>O</sub> = 24 mA V <sub>IN</sub> = 3 V, I <sub>O</sub> = -24 mA	3.0		4.0 10	8.0 19		8.0 19	Ω
		V <sub>IN</sub> = 0 V, I <sub>O</sub> = 8 mA V <sub>IN</sub> = 2.3 V, I <sub>O</sub> = -8 mA	2.3		5.0 13	9.0 24		9.0 24	Ω
		V <sub>IN</sub> = 0 V, I <sub>O</sub> = 4 mA V <sub>IN</sub> = 1.65 V, I <sub>O</sub> = -4 mA	1.65		6.5 17	12 39		12 39	Ω
Icc	Quiescent Supply Current All Channels ON or OFF	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0$	5.5			1.0		10	μΑ
	Analog Signal Range		V <sub>CC</sub>	0		V <sub>CC</sub>	0	V <sub>CC</sub>	V
R <sub>RANGE</sub>	On Resistance Over Signal Range (Note 3) (Note 7)	$\begin{split} I_A &= -30 \text{ mA, } 0 \leq V_{Bn} \leq V_{CC} \\ I_A &= -24 \text{ mA, } 0 \leq V_{Bn} \leq V_{CC} \\ I_A &= -8 \text{ mA, } 0 \leq V_{Bn} \leq V_{CC} \\ I_A &= -4 \text{ mA, } 0 \leq V_{Bn} \leq V_{CC} \end{split}$	4.5 3.0 2.3 1.65					25 50 100 300	Ω
$\Delta R_{ON}$	On Resistance Match Between Channels (Note 3) (Note 4) (Note 5)	$I_A = -30 \text{ mA}, V_{Bn} = 3.15$ $I_A = -24 \text{ mA}, V_{Bn} = 2.1$ $I_A = -8 \text{ mA}, V_{Bn} = 1.6$ $I_A = -4 \text{ mA}, V_{Bn} = 1.15$	4.5 3.0 2.3 1.65		0.15 0.2 0.5 0.5				Ω
R <sub>flat</sub>	On Resistance Flatness (Note 3) (Note 4) (Note 6)	$\begin{array}{l} I_{A} = -30 \text{ mA}, \ 0 \leq V_{Bn} \leq V_{CC} \\ I_{A} = -24 \text{ mA}, \ 0 \leq V_{Bn} \leq V_{CC} \\ I_{A} = -8 \text{ mA}, \ 0 \leq V_{Bn} \leq V_{CC} \\ I_{A} = -4 \text{ mA}, \ 0 \leq V_{Bn} \leq V_{CC} \end{array}$	5.0 3.3 2.5 1.8		5.0 10 24 110				Ω

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

<sup>3.</sup> Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B Ports).

4. Parameter is characterized but not tested in production.

ΔR<sub>ON</sub> = R<sub>ON</sub> max – R<sub>ON</sub> min measured at identical V<sub>CC</sub>, temperature and voltage levels.
 Flatness is defined as the difference between the maximum and minimum value of On Resistance over the specified range of conditions.

<sup>7.</sup> Guaranteed by Design.

# AC ELECTRICAL CHARACTERISTICS ( $T_A = -40$ °C to +85°C)

			V <sub>CC</sub>	T	<sub>A</sub> = +25°	С	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			Figure
Symbol	Parameter	Test Conditions	(V)	Min	Тур	Max	Min	Max	Unit	Number
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Bus to Bus (Note 9)	V <sub>I</sub> = OPEN	1.65–1.95 2.3–2.7 3.0–3.6 4.5–5.5			1.2 0.8 0.3			ns	Figures 2, 3
t <sub>PZL</sub> t <sub>PZH</sub>	Output Enable Time Turn On Time (A to B <sub>n</sub> )	$V_I = 2 \times V_{CC}$ for $t_{PZL}$ $V_I = 0$ V for $t_{PZH}$	1.65–1.95 2.3–2.7 3.0–3.6 4.5–5.5			23 13 6.9 5.2	7.0 3.5 2.5 1.7	24 14 7.6 5.7	ns	Figures 2, 3
t <sub>PLZ</sub> t <sub>PHZ</sub>	Output Disable Time Turn Off Time (A Port to B Port)	$V_I = 2 \times V_{CC}$ for $t_{PLZ}$ $V_I = 0$ V for $t_{PHZ}$	1.65–1.95 2.3–2.7 3.0–3.6 4.5–5.5			12.5 7.0 5.0 3.5	3.0 2.0 1.5 0.8	13 7.5 5.3 3.8	ns	Figures 2, 3
t <sub>BBM</sub>	Break Before Make Time (Note 8)	$R_L = 50 \Omega$ $C_L = 35 pF$	1.65–1.95 2.3–2.7 3.0–3.6 4.5–5.5	0.5 0.5 0.5 0.5			0.5 0.5 0.5 0.5		ns	Figure 4
Q	Charge Injection (Note 8)	$C_L = 0.1 \text{ nF}, V_{GEN} = 0 \text{ V}$ $R_{GEN} = 0 \Omega$	5.0 3.3		7.0 3.0				рС	Figure 5
OIRR	Off Isolation (Note 10) NO	$R_L = 50 \Omega$ f = 10 MHz	1.65–5.5		-55				dB	Figures 6, 16
OIRR	Off Isolation (Note 10) NC	$R_L = 50 \Omega$ f = 10 MHz	1.65–5.5		-48				dB	Figures 6, 16
Xtalk	Crosstalk	$R_L = 50 \Omega$ f = 10 MHz	1.65–5.5		-54				dB	Figure 7
BW	-3 dB Bandwidth	$R_L = 50 \Omega$	2.5–5.5		250				MHz	Figures 10, 15
THD	Total Harmonic Distortion (Note 8)	$R_L = 600 \Omega$ 0.5 $V_{P-P}$ f = 600 Hz to 20 kHz	2.5 5.0		0.014 0.004				%	Figure 11

## **CAPACITANCE** (Note 11)

Symbol	Parameter	Test Conditions	Тур	Max	Unit	Figure Number
C <sub>IN</sub>	Select Pin Input Capacitance	V <sub>CC</sub> = 0 V	2.3		pF	
C <sub>IO-B</sub>	B Port Off Capacitance	V <sub>CC</sub> = 5.0 V	6.5		pF	Figure 8
C <sub>IOA-ON</sub>	A Port Capacitance when Switch is Enabled	V <sub>CC</sub> = 5.0 V	18.5		pF	Figure 9

Guaranteed by Design.
 This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the On Resistance of the switch and the 35 pF load capacitance, when driven by an ideal voltage source (zero output impedance).
 Off Isolation = 20 log<sub>10</sub> [V<sub>A</sub>/V<sub>Bn</sub>].
 T<sub>A</sub> = +25°C, f = 1 MHz, Capacitance is characterized but not tested in production.

**APPENDIX A** DC ELECTRICAL EXTENDED AUTOMOTIVE TEMPERATURE RANGE CHARACTERISTICS (Note 14)

			V <sub>CC</sub>		T <sub>A</sub> = +25°C	;	T <sub>A</sub> = -55°C	°C to +125°C	
Symbol	Parameter	Test Conditions	(V)	Min	Тур	Max	Min	Max	Unit
V <sub>IH</sub>	HIGH Level Input Voltage		1.65–1.95 2.3–5.5				0.75 V <sub>CC</sub> 0.7 V <sub>CC</sub>		V
V <sub>IL</sub>	LOW Level Input Voltage		1.65–1.95 2.3–5.5					0.25 V <sub>CC</sub> 0.3 V <sub>CC</sub>	V
I <sub>IN</sub>	Input Leakage Current	$0 \le V_{IN} \le 5.5 V$	0–5.5		±0.05	±0.1		±1	μΑ
l <sub>OFF</sub>	OFF State Leakage Current	$0 \le A, B \le V_{CC}$	1.65–5.5		±0.05	±0.1		±1	μΑ
R <sub>ON</sub>	Switch On Resistance (Note 12)	$V_{IN} = 0 \text{ V, } I_{O} = 30 \text{ mA}$ $V_{IN} = 2.4 \text{ V, } I_{O} = -30 \text{ mA}$ $V_{IN} = 4.5 \text{ V, } I_{O} = -30 \text{ mA}$	4.5		3.0 5.0 7.0			8.5 13.0 15.0	Ω
		V <sub>IN</sub> = 0 V, I <sub>O</sub> = 24 mA V <sub>IN</sub> = 3 V, I <sub>O</sub> = -24 mA	3.0		4.0 10			11 20	
		V <sub>IN</sub> = 0 V, I <sub>O</sub> = 8 mA V <sub>IN</sub> = 2.3 V, I <sub>O</sub> = -8 mA	2.3		5.0 13			12 30	
		V <sub>IN</sub> = 0 V, I <sub>O</sub> = 4 mA V <sub>IN</sub> = 1.65 V, I <sub>O</sub> = -4 mA	1.65		6.5 17			20 50	
I <sub>CC</sub>	Quiescent Supply Current All Channels ON or OFF	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0$	5.5			1.0		10	μΑ
	Analog Signal Range		V <sub>CC</sub>	0		V <sub>CC</sub>	0	V <sub>CC</sub>	V
R <sub>RANGE</sub>	On Resistance Over Signal Range	$I_A = -30 \text{ mA}, 0 \le V_{Bn} \le V_{CC}$	4.5					25	Ω
	(Note 12) (Note 13)	$I_A$ = -24 mA, $0 \le V_{Bn} \le V_{CC}$ $I_A$ = -8 mA, $0 \le V_{Bn}$	3.0 2.3					50 100	
		$\leq$ V <sub>CC</sub> $I_A = -4$ mA, $0 \leq$ V <sub>Bn</sub> $\leq$ V <sub>CC</sub>	1.65					300	

<sup>12.</sup> Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B Ports).

13. Guaranteed by Design.

14. For ΔR<sub>ON</sub>, R<sub>FLAT</sub> see –40°C to +85°C section.

APPENDIX A
AC ELECTRICAL EXTENDED AUTOMOTIVE TEMPERATURE RANGE CHARACTERISTICS

			$V_{CC}$ $T_{A} = +25^{\circ}C$ $T_{A} = -55^{\circ}C$ to +125°C		V <sub>A</sub> = +25°C		to +125°C		Figure	
Symbol	Parameter	Test Conditions	(V)	Min	Тур	Max	Min	Max	Unit	Number
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Bus to Bus (Note 16)	V <sub>I</sub> = OPEN	1.65–1.95 2.3–2.7 3.0–3.6 4.5–5.5					1.2 0.8 0.3	ns	Figures 2, 3
<sup>†</sup> PZL <sup>†</sup> PZH	Output Enable Time Turn On Time (A to B <sub>n</sub> )	$V_I = 2 \times V_{CC}$ for $t_{PZL}$ $V_I = 0$ V for $t_{PZH}$	1.65–1.95 2.3–2.7 3.0–3.6 4.5–5.5			23 13 6.9 5.2	7.0 3.5 2.5 1.7	24 14 9.0 7.0	ns	Figures 2, 3
t <sub>PLZ</sub> t <sub>PHZ</sub>	Output Disable Time Turn Off Time (A Port to B Port)	$V_I = 2 \times V_{CC}$ for $t_{PLZ}$ $V_I = 0$ V for $t_{PHZ}$	1.65–1.95 2.3–2.7 3.0–3.6 4.5–5.5			12.5 7.0 5.0 3.5	3.0 2.0 1.5 0.8	13 7.5 6.5 5.0	ns	Figures 2, 3
t <sub>B-M</sub>	Break Before Make Time (Note 15)		1.65–1.95 2.3–2.7 3.0–3.6 4.5–5.5				0.5 0.5 0.5 0.5		ns	Figure 4

<sup>15.</sup> Guaranteed by Design.

<sup>16.</sup> This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).

# **AC LOADING AND WAVEFORMS**

NOTE: Input driven by 50  $\Omega$  source terminated in 50  $\Omega$ 

NOTE:  $C_L$  includes load and stray capacitance NOTE: Input PRR = 1.0 MHz;  $t_W$  = 500 ns

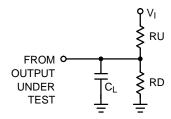
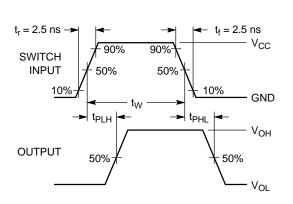


Figure 2. AC Test Circuit



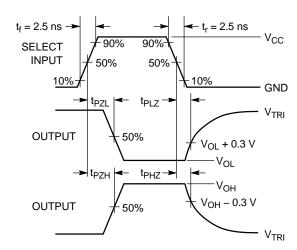
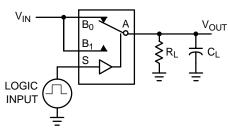


Figure 3. AC Waveforms



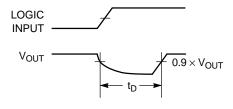


Figure 4. Break Before Make Interval Timing

### **AC LOADING AND WAVEFORMS**

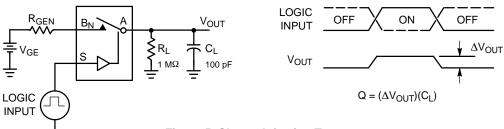


Figure 5. Charge Injection Test

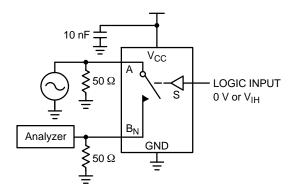


Figure 6. Off Isolation

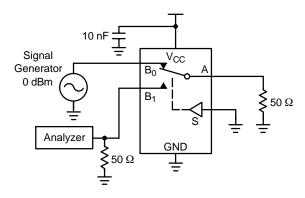


Figure 7. Crosstalk

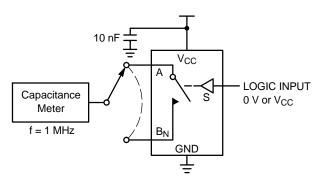


Figure 8. Channel Off Capacitance

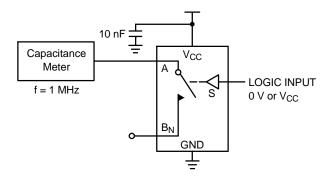


Figure 9. Channel On Capacitance

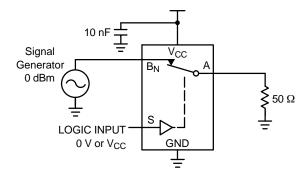


Figure 10. Bandwidth

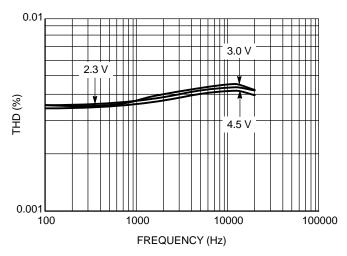


Figure 11. Total Harmonic Distortion vs. Frequency

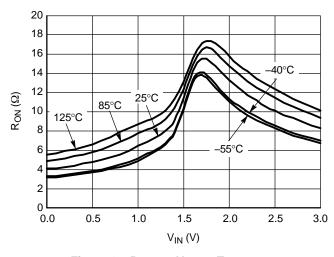


Figure 12.  $R_{ON}$  vs.  $V_{IN}$  vs. Temperature @  $V_{CC}$  = 3.0 V

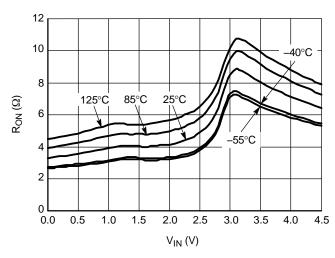


Figure 13.  $R_{ON}$  vs.  $V_{IN}$  vs. Temperature @  $V_{CC}$  = 4.5 V

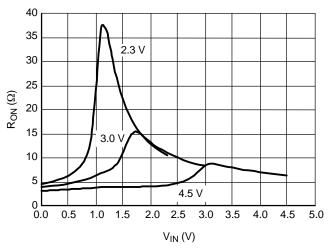


Figure 14. On-Resistance vs. Input Voltage

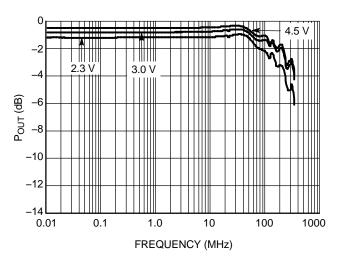


Figure 15. Bandwidth vs. Frequency

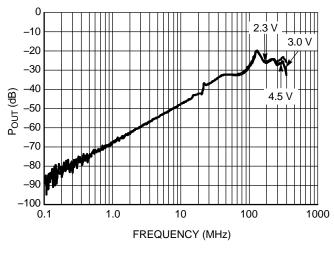


Figure 16. Off-Isolation vs. Frequency

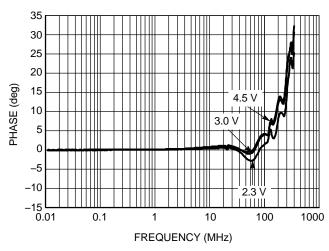


Figure 17. Phase Angle vs. Frequency

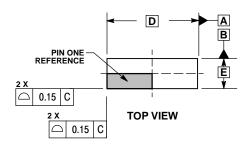
# **DEVICE ORDERING INFORMATION**

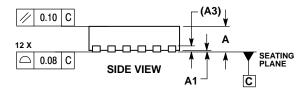
Device Order Number	Package Type	Tape & Reel Size <sup>†</sup>
NLAS3158MNR2G	WDFN12 (Pb-Free)	3000 Unit / Reel

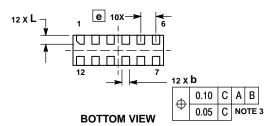
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### PACKAGE DIMENSIONS

#### WDFN12 3.0x1.0, 0.5P CASE 485AG **ISSUE A**







#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION b APPLIES TO TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.

  COPLANARITY APPLIES TO THE EXPOSED
- PAD AS WELL AS THE TERMINALS.

	MILLIMETERS					
DIM	MIN	MAX				
Α	0.70	0.80				
A1	0.00	0.05				
А3	0.20	REF				
b	0.18	0.30				
D	3.00	BSC				
Е	1.00 BSC					
е	0.50 BSC					
L	0.20	0.40				

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